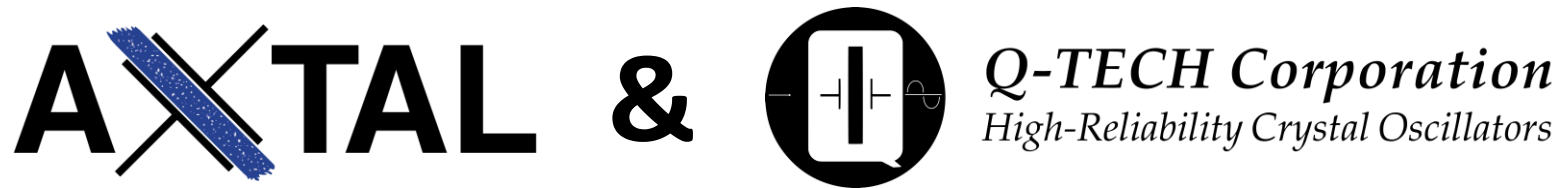


Next-Gen Crystal Oscillators for advanced New Space Applications



Joint Product Portfolio

Presenter: Henry Halang (MD of AXTAL)



5TH SPACE PASSIVE COMPONENT DAYS - SPCD 2024

15-18 October 2024 | ESA/ESTEC

Noordwijk, The Netherlands

Our Companies



- ✕ **AXTAL GmbH** was founded in 2003 by Bernd & Brigitte Neubig as privately-owned company. Since 2023 AXTAL is an independent German subsidiary of the US-based **Q-Tech Corporation**.
- ✕ **AXTAL** manufactures oscillators for Classical space since 2011 including ESA EPPL listed models and started to design & manufacture New Space oscillators about 10 years ago.
- ✕ **Q-Tech** was founded in 1972 with the objective of providing state-of-the-art crystal oscillators and frequency control solutions for demanding applications. Q-Tech is also privately owned since its foundation.
- ✕ **Q-Tech's** main product focus is on high-reliability crystal oscillators for Military, Aerospace & Space and High Temperature Applications.
- ✕ **AXTAL & Q-Tech** combined have more than 60 years of experience in the design and manufacturing of oscillators for Space Applications.
- ✕ **AXTAL & Q-Tech** have built an extensive New Space portfolio over the last years covering all types of crystal oscillators & technologies.

Our New Space Product Portfolio



Clocks (XO)



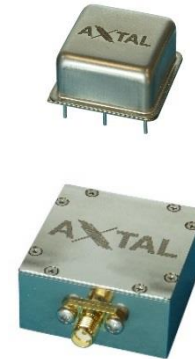
VCXO



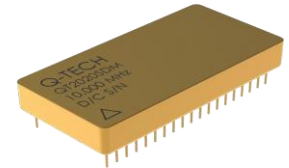
TCXO



OCXO



MCXO



Frequency range:	1.5 MHz ~ 400 MHz (higher frequencies under development)
Package sizes:	From small 2.5x3.2 mm ceramic SMD to 38x38 mm with SMA
Stability:	From ppm (10^{-6}) down to the sub-ppb (10^{-10}) range
Phase noise:	Strong focus on low noise & ultra-low noise designs
Features:	Unique MCXO: lowest power consumption with OCXO stability
Reliability:	Verified Radiation Hardness – MTBF for 15+ years missions

Reliability & Missions




- ✕ **Radiation (TID):** All our New Space oscillator series have been low dose tested up to at least 50 krad (Si) with excellent results and no detected failures.
- ✕ **Radiation (SEE):** Our New Space oscillators are either SEE insensitive by design or have been fully tested showing SEL immunity up to at least 75 MeV·cm²/mg.
- ✕ **Acceptance Testing:** MIL-PRF-55310 Level B, B+ and S or customer requirements.
- ✕ **Customization:** Many options for customization – component and material selection, test procedures for acceptance testing from screening to qualification.
- ✕ **Quartz crystal:** High-Q Quartz, optional Swept Quartz (increased radiation hardness).
- ✕ **Missions:** Our New Space oscillators are suitable for various LEO & MEO missions. Special COTS+ designs suitable for GEO missions are available.
- ✕ **Heritage:** LEO, MEO and GEO missions including small and Mega Constellations.
- ✕ **Data:** Various test, radiation and qualification reports can be provided on request.

Thank you!

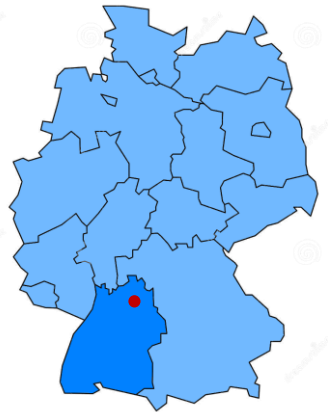


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See us @ Conference

Henry Halang
(Managing Director)

Bernd Neubig
(Consultant)

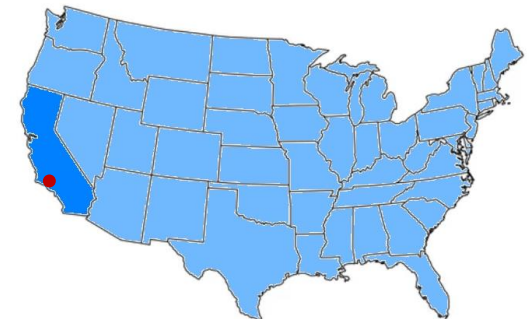
Dilek Sarikaya
(Sales Director)

Q-Tech Corporation

6161 Chip Ave.
Cypress, CA 90630
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www.q-tech.com 





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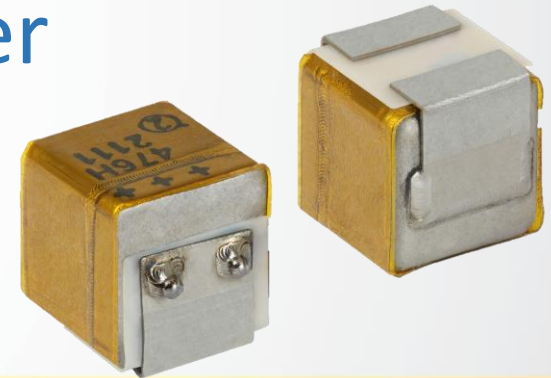
www.vishay.com



The DNA of tech.™

T27 vPolyTan™ Hermetically Sealed Polymer Surface-Mount Chip Capacitors, Low ESR

Designed to Deliver High Performance and Stability in Challenging Environments over Extended Periods of Time



POLYMER ADVANTAGES

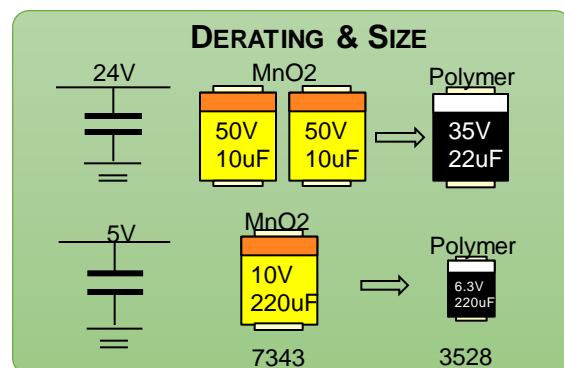
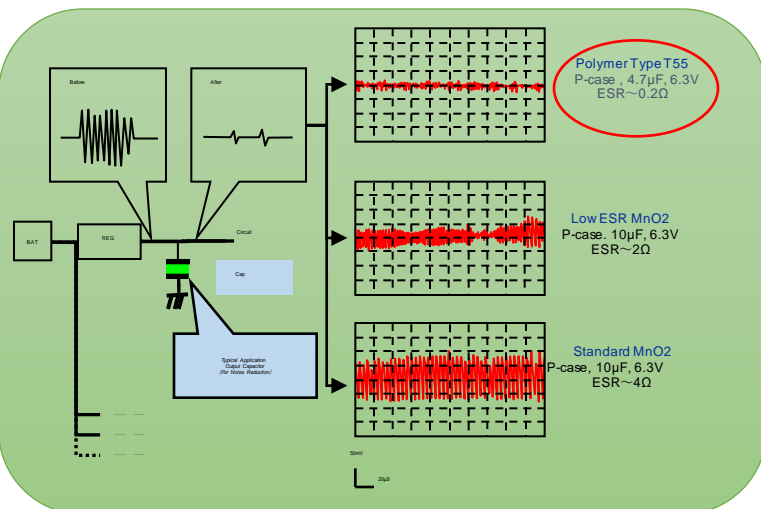
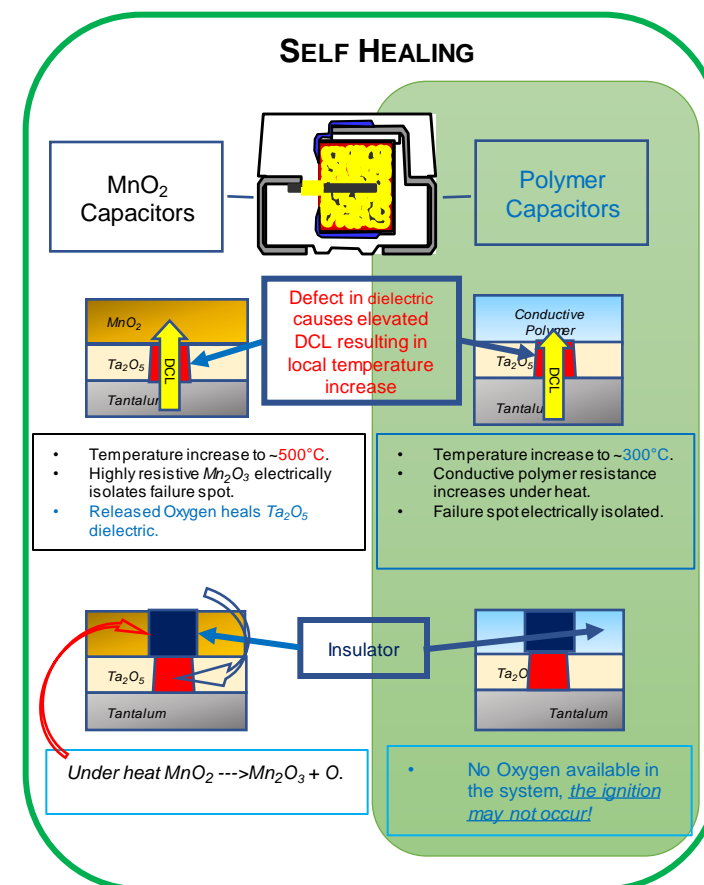
Tantalum Polymer cathode used more and more in power conversion filtering and backup application and ease design work for

❑ Power conversion / energy storage (backup) /detonation /quick energy release (fast boot up) and may open the door to new electronic application in Space applications with thanks to

- ❑ lower ESR
- ❑ Safety of defect mode
- ❑ Smaller case size / lower weight
- ❑ lower derating requirements
- ❑ Higher working voltage (GaN usage)
- ❑ High Energy density

Keeping most of MnO2 advantages

- ❑ Self healing
- ❑ No cap drop with
 - ✓ Time (within recommended parameters)
 - ✓ DC BIAS
 - ✓ Temperature (< 100°C recommended)
 - ✓ Mechanical stress / Piezo effect
 - ✓ Radiation



POLYMER LIMITATIONS

Issues and limitations, encountered by designer and manufacturer are


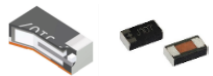
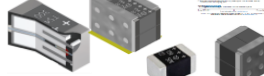

- ❑ Thermo Oxidation of polymer (humidity) leading to cap variations, DCL increase and ESR increase
- ❑ Sensibility to temperature (not above 150°C like MnO₂)
- ❑ ACC phenomena
- ❑ cap stability in time
- ❑ higher DCL than MnO₂ (issue for power saving, serie association and detonation)

But for space applications, benefits are significant providing some precaution are taken

- ❑ AECQ 200 grade or similar proven design (MIL 32700, specific testing)
- ❑ Sufficient extra derating (usually 50% vs 20% recommanded)
- ❑ Controlled Temperature

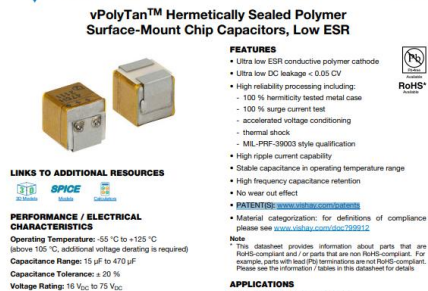
On a space manufacturing point of view this sensitivity to humidity and high temperature is a constaint during

- ❑ Reflow / soldering process
- ❑ Storage of components => require bake out
- ❑ Storage of board => difficult to control

T52 HI ENERGY LOW PROFILE	T58 ULTRA COMPACT SMALL CASE SIZE	T54 EXTENDED RANGE HI-REL COTS	T51 AECQ-200 AUTOMOTIVE GRADE
			
<ul style="list-style-type: none"> ❑ Operating Temperature: - 55°C to +105°C ❑ Capacitance Range: 47µF to 470µF ❑ Capacitance Tolerance: ±10% ± 20% ❑ Voltage Range: 10 VDC to 35 VDC ❑ Case size: <ul style="list-style-type: none"> ➢ E5 – 7343 - 1.5 (single anode), ➢ M1 – 7360 - 2.0 (double anode) ➢ M9 7360 - 1.9 ➢ B2 – 3528- 1.2 	<ul style="list-style-type: none"> ❑ Operating Temp: -55 °C to +105 °C ❑ Capacitance Range: 1 µF to 330 µF ❑ Capacitance Tolerance: ± 20 % ❑ Voltage Rating: 6.3 VDC to 35 VDC ❑ L-shaped face-down termination ❑ 100 % surge current, ❑ Case Size <ul style="list-style-type: none"> ➢ MM 1608-09 ➢ W9 2012-09 ➢ W0 2012-10 ➢ A0 3216-10 	<ul style="list-style-type: none"> ❑ Operating Temp: - 55°C to +125°C ❑ Cap: 30µF to 2800µF ❑ Tol: ±10% & ± 20% ❑ Voltage: 16 VDC to 75 VDC ❑ EE Case (7.3 x 4.3 x 4.3mm L and EL-Shape termination. ❑ T54 Reliability : <ul style="list-style-type: none"> ➢ 100 % surge current ➢ Accelerated voltage conditioning ➢ Thermal shock ➢ Statistical DC leakage screening at elevated temperature and voltage. ❑ Stack version available (2, 3, 4, 6) ❑ DLA 20021 version available 	<ul style="list-style-type: none"> ❑ Conductive polymer electrode ❑ Full compliance with AEC-Q200 ❑ -55C to +125C operation temperature ❑ Humidity 85C/85% RH, VR, (1,000 hours) ❑ EIA Case Sizes – B, D & V ❑ Humidity 85C/85% RH VR 1000 hrs ❑ J Lead molded type

VISHAY

The DNA of tech.™



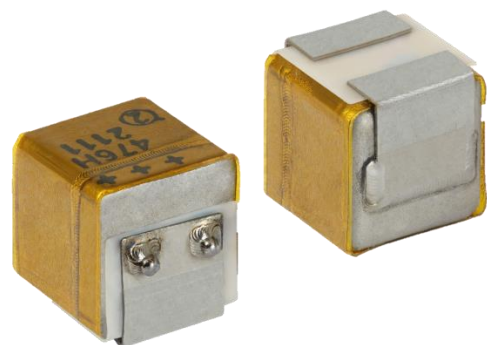
ORDERING INFORMATION							
TYPE	D	226	M	OC3	E	S	ESD
	TYPE CODE	CAPACITANCE TOLERANCE	TEMPERATURE RATING	TEMPERATURE PACKAGING	RELIABILITY LEVEL	"SURGE" CURRENT LEVEL	ESD LEVEL
		M = ±20 %		See Pin 17 section = 171 °F (78 °C) reel = 171 °F (78 °C) tape = 171 °F (78 °C) bag = 171 °F (78 °C) partial reel		A = 100 pulses B = +25 °C C = 55 °C D = 85 °C	Maximum 1000 ESD
		This capacitor is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow to arrive to		See Pin 16 = 171 °F (78 °C) reel = 171 °F (78 °C) tape = 171 °F (78 °C) bag = 171 °F (78 °C) partial reel			

PATENT(S): www.vishay.com/patents
This Vishay product is protected by one or more United States and international patents.

Revision: 14-Jul-2022 1 Document Number: 40277

For technical questions, contact: politech@vishay.com

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ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



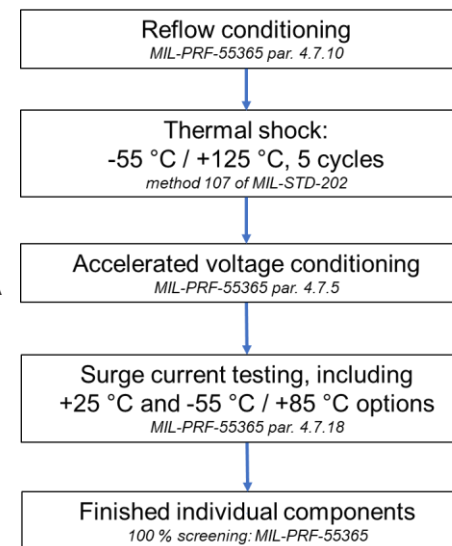
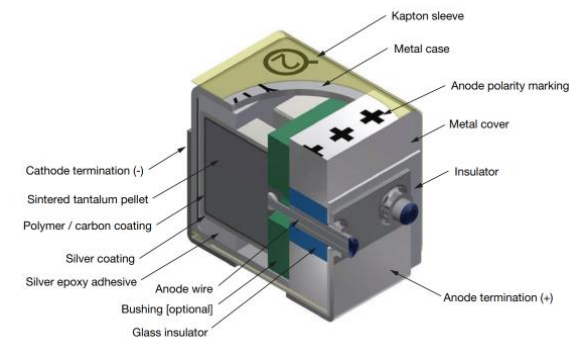
a better parametric stability and predictable behaviour of component may be required during design and longer missions.

By using and applying

- ❑ **100 % hermiticity tested metal case** (Fixed enclosed atmosphere, fixed humidity) based on DLA wet tantalum space qualified)
- ❑ **Advanced anode manufacturing and proprietary process** (delub, welded anode, crystal free anode)
- ❑ **appropriate derating,**

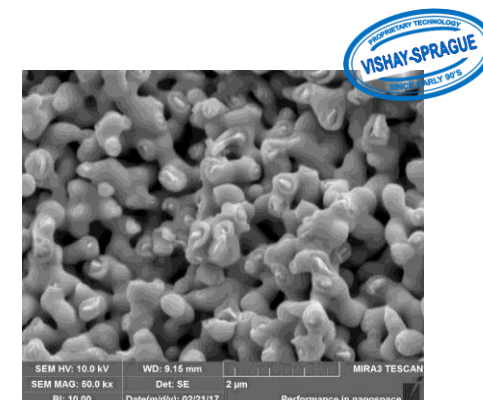
all drifts due to Thermo Oxidation and ACC can be kept below acceptable levels

=> High Performance and Stability in Challenging Environments over Extended Periods of Time



MIL-PRF-55365J	
Charge time (ms)	Capacitance value (pF)
1	≤ 330
10	> 330 and ≤ 3300
100	> 3300

MIL-PRF-32700	
Maximum Charge time (ms)	Capacitance value (pF)
10	≤ 47
25	≥ 47 and ≤ 100

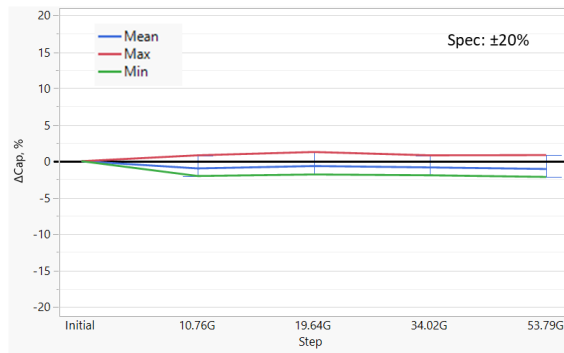


PATENT(S): www.vishay.com/patents

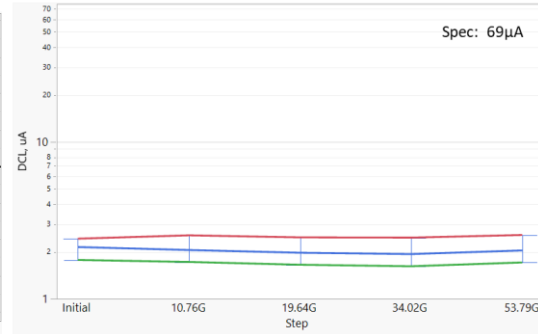
T27 STABILITY & LIFETEST

Mechanical: Stability after Random Vibration

Δ Capacitance %

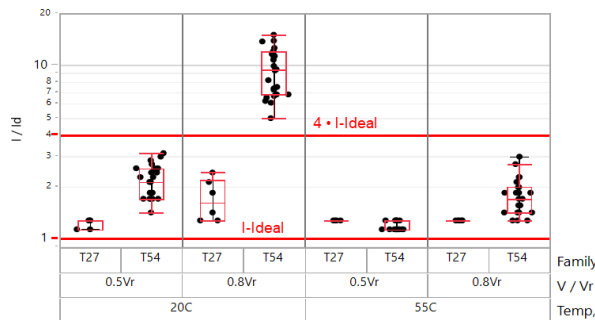


Δ DCL

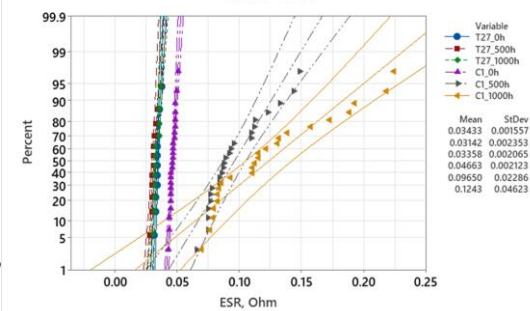


Reduced effects of ACC (stable parameters)

330 μ F – 16V

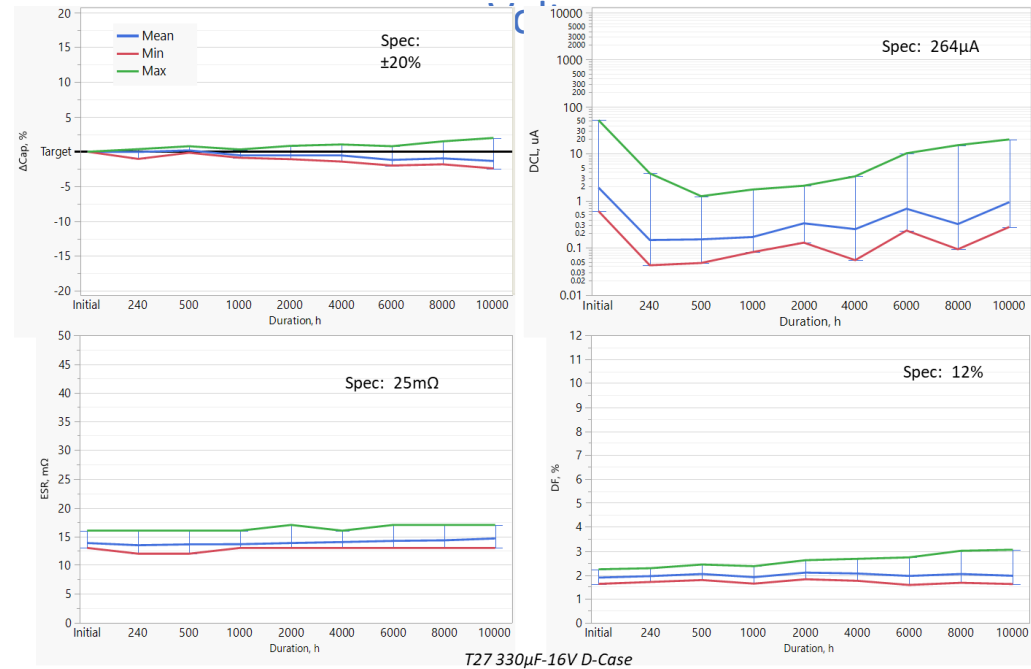


ESR of Vishay Hermetic T27 vs. Competitor's Non-Hermetic Automotive

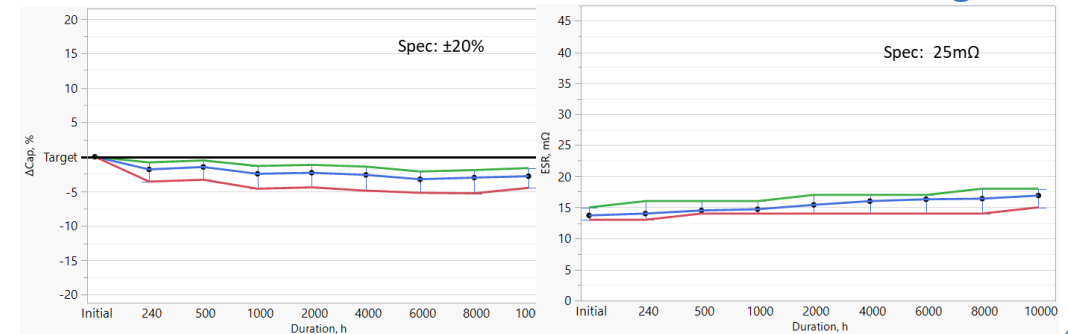


Stable electrical performance over lifetime

➤ Life Test: 10,000 hours at 85°C and Rated



➤ 10,000 hours at 125°C and 2/3 Rated Voltage



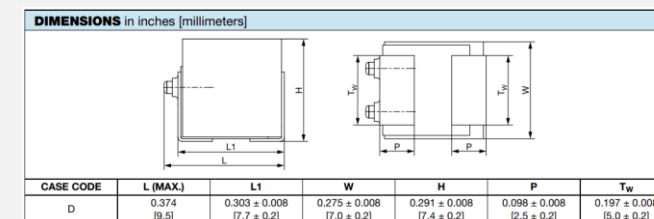
T27 SERIES HERMETIC POLYMER

Electrical Characteristics

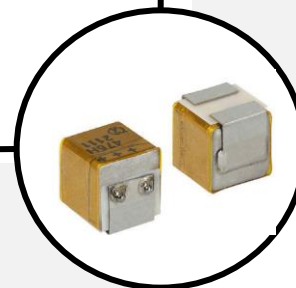
- ❑ Operating Temperature: -55°C to +125°C
 - ❑ (above 105°C, additional voltage derating required)
- ❑ Capacitance Range: 15µF to 470µF
- ❑ Voltage Range: 16Vdc to 75Vdc
- ❑ DC Leakage <0.05 CV

Mechanical

- ❑ Case size:



- ❑ Mass: T27 ~ 1.7g (T54 ~ 0.623g)
- ❑ Mechanical and electrical Design based on enclosure T22 wet tantalum [DLA 19001](#) and Anode on T54 [DLA 20021](#)



Advantages

- ❑ High reliability processing including:
 - ✓ 100% hermiticity tested metal case
 - ✓ 100% surge current test
 - ✓ Accelerated voltage conditioning
 - ✓ thermal shock
 - ✓ MIL-PRF-39003 style qualification
- ❑ High ripple current capability
- ❑ Stable capacitance in operating temperature range
- ❑ No wear out effect

RATINGS AND CASE CODES (ESR, mΩ)						
µF	16 V	25 V	35 V	50 V	63 V	75 V
15					D (100) ⁽¹⁾	D (100) ⁽¹⁾
22				D (100) ⁽¹⁾	D (100) ⁽¹⁾	D (100) ⁽¹⁾
33				D (100) ⁽¹⁾	D (100) ⁽¹⁾	
47			D (70) ⁽¹⁾	D (100)		
150			D (100) ⁽¹⁾			
220		D (55) ⁽¹⁾				
330	D (25)					
470	D (25) ⁽¹⁾					





ACCELERATING
INNOVATION

KAVX Hi Rel CAPACITORS ROADMAP

September 30th, 2024



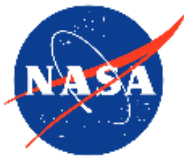
CERTIFICATIONS



Qualified by European Space Agency (ESA)
ESCC 3012/001 (TAJ ESCC)
ESCC 3012/004 (TES Series)
ESCC 3012/006 (TCS ESCC Series)
ECCC 3009/034 (High Voltage X7R MLCC)
ESCC 3009/041 (BME X7R MLCC)
ESCC 3009 (PME X7R / NP0 MLCC)
ESCC 3001 (X7R Stacks)



Qualified by Defense Logistic Agency (DLA)
MIL-PRF-55365/4 (CWR09)
MIL-PRF-55365/8 (CWR 11)
MIL-PRF-55365/11 (CWR19 and 29)
MIL-PRF-55365/12 (CWR 15 – Ta-Microchips)
DLA 07016 (TBJ)
DLA 95158 (TBJ)
DLA 04051 (TCD - Conductive polymer capacitors)
MIL-PRF-39006 (22/25/30/31/33) Ta-WET capacitors (CLR 93 style)
DLA 13017 (Ta-WET capacitors)
DLA 93026 (Ta-WET capacitors)

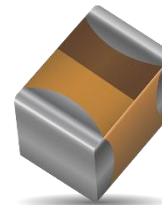
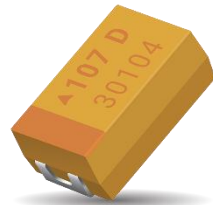
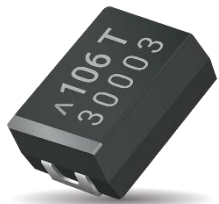


Qualified by NASA
G311P838
(MLCC)

HI-REL TA PRODUCT OVERVIEW

COTS+ Aerospace

SRC8000 (LEO)
SRC9000
SRW9000 (WET capacitors)



European Standardization Based

ESCC ESA qualified products

3012/001
3012/004 (Low ESR)
3012/006 (Conductive polymer)

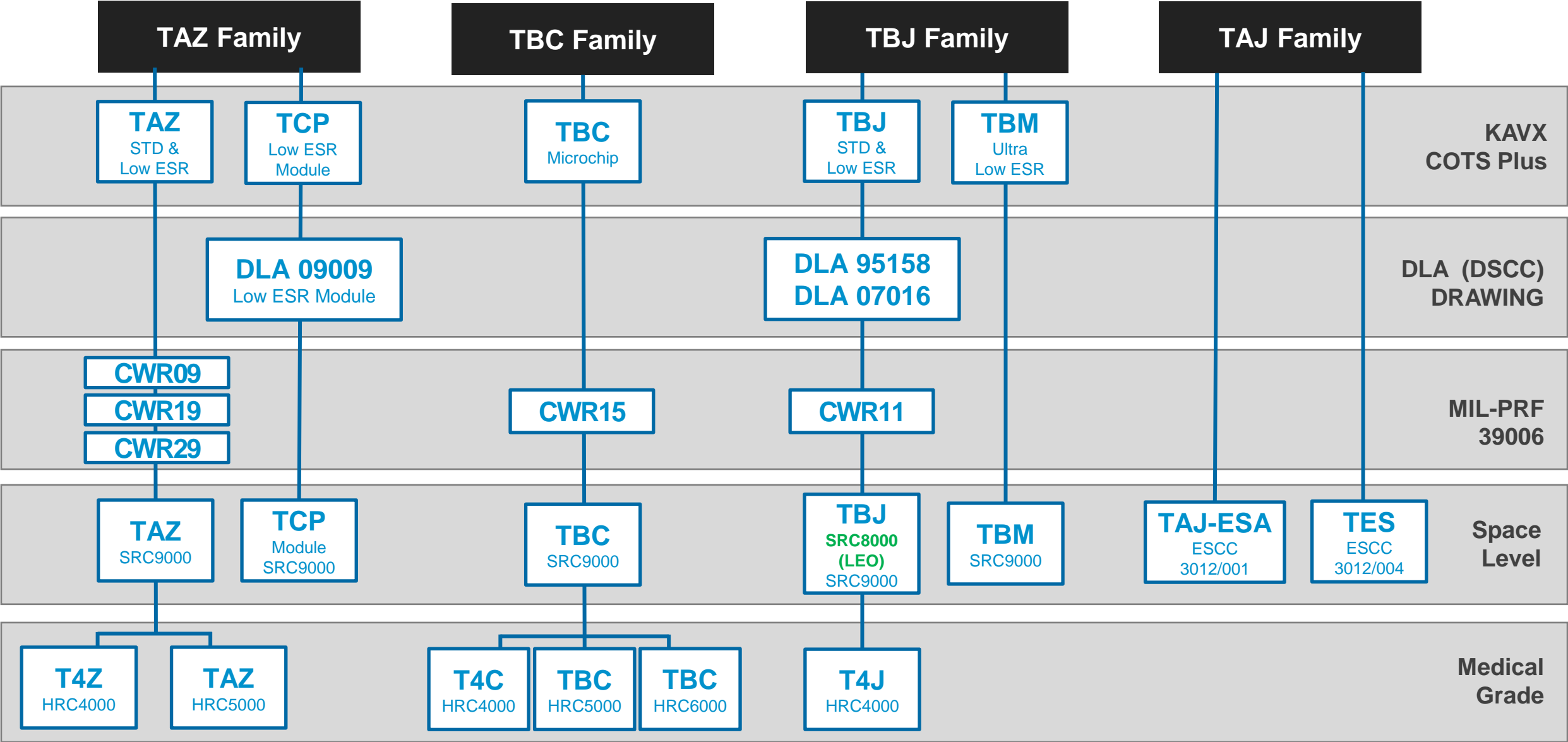
US Standardization Based

MIL group family

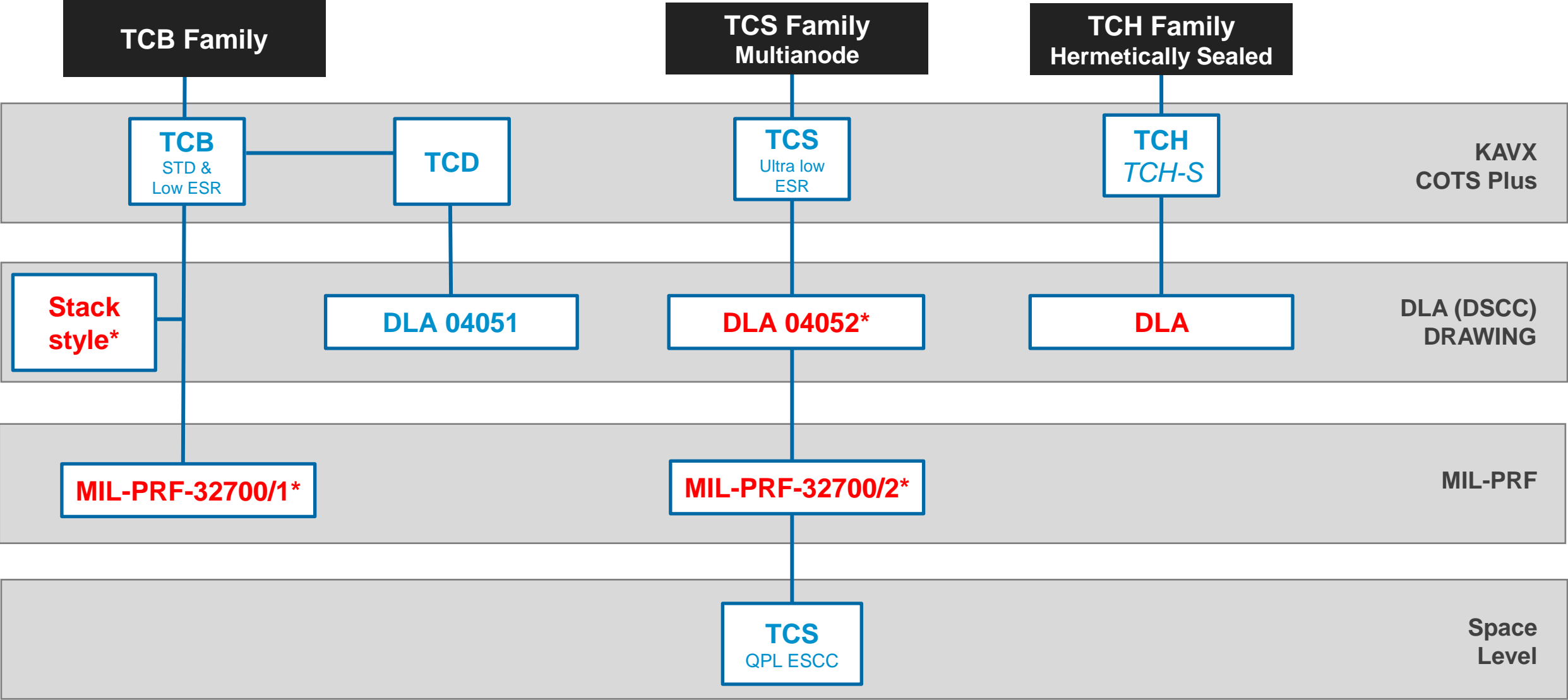
CWR 09
CWR 11
CWR 15 (Microchip)
CWR 19 (Ext. range)
CWR 29 (Low ESR)

DLA 95158
DLA 07016 (Low ESR, ext. range)
DLA 04051 (Conductive polymer)
DLA 93026 (Wet)
DLA 13017 (Wet)

HIGH RELIABILITY SERIES LINE | TANTALUM CAPACITORS

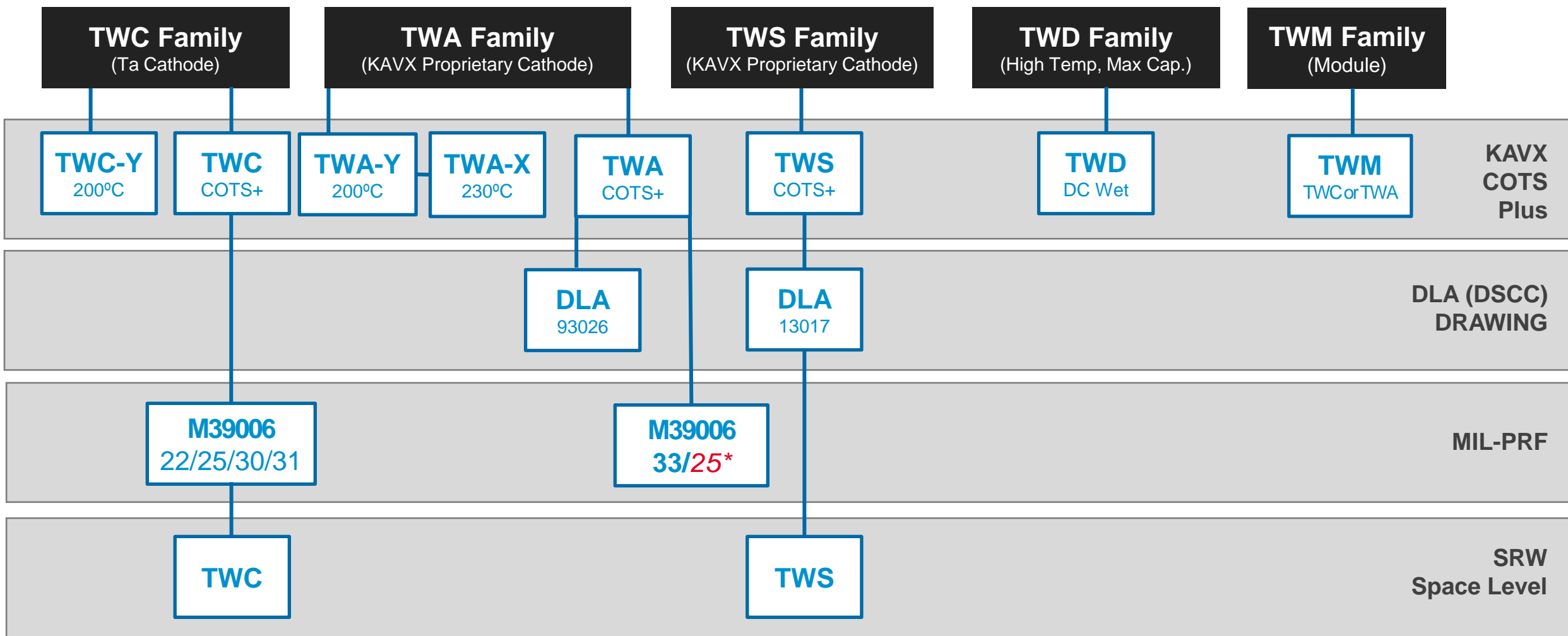


HIGH RELIABILITY SERIES LINE | POLYMER CAPACITORS



* Under qualification

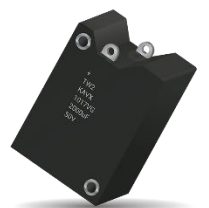
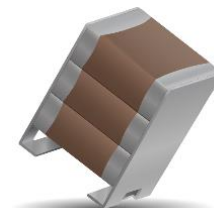
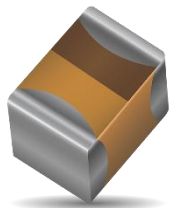
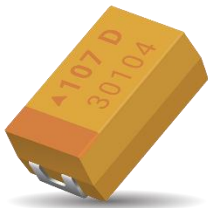
AXIAL LEADED SERIES LINE | WET ELECTROLYTIC CAPACITORS



Wet Tantalum produced in Biddeford for USA (MIL) and Lanskroun, Czech Republic

* Under qualification

- HIGH REL PRODUCTS FOR HIGH END MARKET
- R&D FOCUS ON POLYMERS
- CV EXPANSION ON LEO APPLICATIONS
- DEVELOPING NEW BUSINESS OPPORTUNITIES



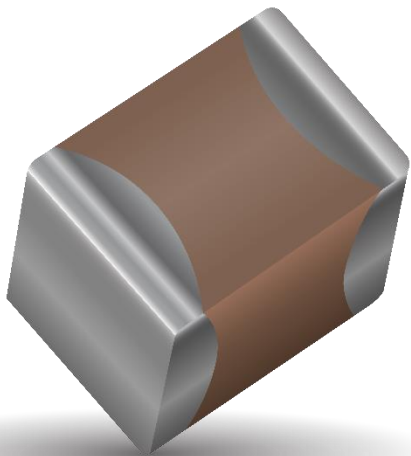
KAVX Space/Mil Ceramic Road Map

Space/Mil X7R extension plan

- Lower voltages, 10 volts , smaller case sizes higher capacitance
- Large cases (1812 and 2220) , 50 to 100 volts.

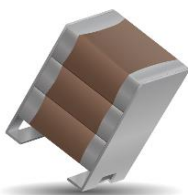
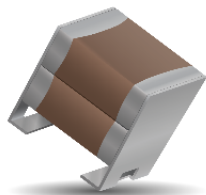
QPL M32535 NP0 range development

- Phase I: approved (Nov 2022)
- Phase II: expansion to 1206 - 1210 (Q4 CY 2024)
- Phase III: aimed at higher CV within 0402 - 0805 values (Q4 CY 2025)



QPL Mil stack Mini BME range

- Using core technology and knowledge from mil /space production line
- 2220 inserts in a 2 or 3 horizontal chip stack as a first step.
- Followed by 2220 inserts used in vertical stacks , min 3 to max 10 chip inserts.









Space Level MBH20... Series			
Voltage			
Cap u F	M Tol	10/16/25	50
10			X2
12			X2
15			X3
18			X3
22			X2
27	X2	X3	
33	X2	X3	
47	X2	X3	
56	X3		
68	X3		
100			
120			
150			
180			
220			

KAVX High Rel Product Guide





CERAMIC CAPACITORS

SURFACE MOUNT CERAMIC CAPACITORS

NASA		ESA ESCC QPL	
 <ul style="list-style-type: none">QPL BME technology availableHigh CV technology enabling case size downsizing, PCB weight and size reductionFLEXITEM™ for enhanced mechanical stress resistance available for BMESnPb termination for BME		 <ul style="list-style-type: none">QPL BME and PME technologies availableLow ESR / ESL compared to other technologiesFLEXITEM™ for enhanced mechanical stress resistance available for BMEPdAg or SnPb terminations for PME, SnPb termination for BME	
Oper. Temp: -55°C to +125°C Case: 0603 - 2220 Voltage: 16V - 100V Capacitance: 2.2 nF - 8.2 µF	NASA S-311-P-838	Oper. Temp: -55°C to +125°C Case: 0402 - 2220 Voltage: 16V - 3kV Capacitance: 2.2 nF - 22 µF	ESCC 3009 • ESA 3009034 ESCC 3009041
MIL PRF 32535		CECC	
 <ul style="list-style-type: none">M and T reliability levels availableHigher CV capability for PCB weight/size reductionFlexitem™ technology for greater protectionMax cap value 22 µFTermination with SnPb		 <ul style="list-style-type: none">PME technology availableNPO and X7R technologies availableTerminations: Hybrid, Ni/Sn/Pb, Ni/SnBurn in options available from 0/48/96/168 hoursCapacitance Tolerance from 1% to 20% available	
Oper. Temp: -55°C to +150°C Case: 0402 - 2225 Voltage: 16V - 100V Capacitance: 2.2 nF - 22 µF	MIL PRF 32535	Oper. Temp: -55°C to +125°C Case: 0603 - 2220 Voltage: 25V - 500V Capacitance: 4.7 pF - 1.5 µF	CECC 32101 • CECC 32100
MIL / DSCC / DLA / COTS-PLUS		HIGH TEMPERATURE AT RANGE	
 <ul style="list-style-type: none">MIL/DSCC dielectrics BP, BG and where wider variation can be accepted, BX, BRAPS COTS Plus dielectrics NPO, X7R, X8R, X9RLow ESR / ESL compared to other technologiesAu, PdAg, Tin Lead or Pure Tin terminations availableAPS COTS Plus X7R available with Flexitem™		 <ul style="list-style-type: none">Max Temperature Range 250°CTerminations PdAg, SN, NiAuDielectrics: VHT (Class II) and COG/NPO (Class I)Uses PME and BME technologies for maximum capacitance ranges	
Oper. Temp: -55°C to +150°C Case: 0402 - 2225 Voltage: 10V - 500V Capacitance: 0.1 µF - 22 µF	MIL PRF 123 • MIL PRF 55681 (CDR) APS COTS+ • DSCC 03029 (0402) DSCC 03028 (0603) • DSCC 06036 (0605) DSCC 05007 (1206)	Oper. Temp: -55°C to +250°C Case: 0603 - 2225 Voltage: 10V - 50V Capacitance: 2.2 nF - 1 µF	MIL STD 202

LEADED CERAMIC CAPACITORS



MIL / DSCC / DLA / BS9100		ESA ESCC / CECC	
 <ul style="list-style-type: none">Excellent reliability and low ESR / ESL compared to other capacitor technologiesRadial & Axial epoxy encapsulated for harsh environmentHigh voltage range 1-5kV also available		 <ul style="list-style-type: none">QPL PME technologies availableExcellent reliability and low ESR / ESL compared to other capacitor technologiesHigh voltage range 1-5kV also availableA range of lead types: Leaded Radial (Epoxy coated, Polyurethane Varnish), Straight Dual In Line, L Dual In Line	
Oper. Temp: -55°C to +125°C Case: Radial, Axial Voltage: 50V - 5000V Capacitance: 1 pF - 2 µF	MIL PRF 20 • MIL PRF 123 • MIL PRF 11015 MIL PRF 39014 • DSCC 87046 • DSCC 87114 DSCC 87081 • DSCC 87043 • DSCC 87047 DSCC 87040 • DSCC 87076 • DSCC 87077 DSCC 89044 • DSCC 87070 • BS9100	Oper. Temp: -55°C to +125°C Case: Radial Voltage: 50V - 5000V Capacitance: 820 pF - 180 µF	ESCC 3001030 • ESCC 3001034 CECC 30701

CERAMIC CAPACITORS

RF SURFACE MOUNT CERAMIC CAPACITOR





MIL / DSCC / DLA / COTS-PLUS	
 <ul style="list-style-type: none">High Q ultra low ESRHigh current handlingHigh self resonanceBG and BP dielectrics	<ul style="list-style-type: none">Tight tolerances from ±0.01 pFAu, PdAg, Tin Lead or Pure Tin terminations
Oper. Temp: -55°C to +125°C Case: 01005 - 1210 Voltage: 50V - 500V Capacitance: 0.1 pF - 5100 pF	MIL PRF 55681 (CDR) MIL PRF 123 • DSCC 06019 (0605) DSCC 06022 (1210)

SWITCH MODE POWER SUPPLY CAPACITORS (SMPS)

MIL / DSCC / BS9100		ESA ESCC / CECC	
 <ul style="list-style-type: none">Designed for programs requiring high reliability performance in harsh environmentSuitable for high current, high power & high temperature applicationsLow ESR / ESL & excellent high frequency performance compared to other technologies		 <ul style="list-style-type: none">Designed for space based programs requiring ultra-high reliability performanceDesigned for high current, high power applicationsLow ESR / ESL and excellent high frequency performanceA range of lead types: Leaded Radial (Epoxy coated, Polyurethane Varnish), Straight Dual In Line, L Dual In Line	
Oper. Temp: -55°C to +200°C Case: Stacked Voltage: 50V - 500V Capacitance: 0.15 µF - 270 µF	MIL-PRF-49470 • BS9100 DSCC 87106/89011	Oper. Temp: -55°C to +125°C Case: Stacked, Radial Voltage: 50V - 500V Capacitance: 820 pF - 180 µF	ESCC 3001030 • ESCC 3001034 CECC 30701 ESCC 3012 (in preparation)


TANTALUM & POLYMER CAPACITORS

SURFACE MOUNT TANTALUM & POLYMER


MIL / DSCC / DLA / SRC / COTS-PLUS		ESA ESCC / CECC	
 <ul style="list-style-type: none">TAZ (CWR), TBJ, TBM, TCS, TCP SeriesAvailable with MnO₂ or polymer cathode in SMD chip case sizePolymer offers low ESR & higher inrush current robustnessMnO₂ chips & multilayers offer excellent reliability & are qualified to the highest MIL/Space reliability levels		 <ul style="list-style-type: none">TES, TAJ, TAJ ESCCLong term stability, high capacitance in small case sizesManufactured in EU, ESA qualified plantTCS - polymer multilayer - ongoing ESA qualification	
Oper. Temp: -55°C to +105/125°C Case: SMD Voltage: 2V - 50V Capacitance: 0.1 µF - 1500 µF	MIL-PRF-55365 (CWR) MIL PRF 55365 (T Level) • SRC3000 DSCC 07016 • DSCC 95158 DSCC 09009 • COTS-Plus	Oper. Temp: -55°C to +125°C Case: 3216 - 7343 Voltage: 4V - 50V Capacitance: 0.1 µF - 470 µF	ESCC 3012004 • ESCC 3012001 CECC 30801-01 • CECC 30801-005
MIL / SRC / COTS-PLUS		ESA EPPL2 (under preparation)	
 <ul style="list-style-type: none">TBC (CWR) microchipAvailable in standard MnO₂ SMD chip with case sizes down to 0603MnO₂ chips offer excellent reliability and parameters stability over temperature, voltage, and timeQualified to the highest MIL/Space reliability levels		 <ul style="list-style-type: none">TCH Low ESR Hermetic SeriesDesigned for Aerospace & H-Rel applicationsEndurance minimum up to 10,000 hrs. on selected codesExcellent stability under humidity and ambient conditions due to ceramic case hermetic packagingEffective up-screen testing for high reliability	
Oper. Temp: -55°C to +125°C Case: 0603, 0805, 1206 Voltage: 4V - 20V Capacitance: 0.47 µF - 68 µF	COTS-Plus • SRC9000 MIL-PRF-55365/12 (CRW)	Oper. Temp: -55°C to +125°C Case: (CTC-21D) Voltage: 10V - 100V Capacitance: 22 µF - 330 µF	ESCC 3012 (in preparation)

TANTALUM & POLYMER CAPACITORS

WET ELECTROLYTIC TANTALUM


SRW / MIL / DSCC / DLA / COTS-PLUS	
 <ul style="list-style-type: none">TWA, TWA-X, TWA-Y, TWC, TWC-Y, TWM, TWD, TWSIncludes a welded tantalum can & header assembly that provides a hermetic seal to withstand harsh shock & vibration requirementsCustomized capacitance & voltage ratings are possibleTWC-Y and TWA-Y capable of continuous operation at 200°C, TWA-X 230°C	<ul style="list-style-type: none">Includes a welded tantalum can & header assembly that provides a hermetic seal to withstand harsh shock & vibration requirementsCustomized capacitance & voltage ratings are possibleTWC-Y and TWA-Y capable of continuous operation at 200°C, TWA-X 230°C
Oper. Temp: -55°C to +200/230°C Case: T1, T2, T3, T4, TWM module Voltage: 6V - 125V Capacitance: 2.5 µF - 50 mF	DSCC 93026 • SRW9000 MIL-PRF-39006 • COTS-Plus

LEADED TANTALUM


CECC	
 <ul style="list-style-type: none">Tantalum Capacitors with dipped resin encapsulation with SnPb terminationsOptional radial lead wire terminationsLow leakage currentVery small physical sizesExcellent temperature stability	
Oper. Temp: -55°C to +125°C Case: Radial Voltage: 6.3V - 50V Capacitance: 0.1 µF - 330 µF	CECC 30201-032

THIN FILM PRODUCTS

RF THIN FILM CAPACITORS

DLA	
 <ul style="list-style-type: none">Ultra tight capacitance tolerancesLow ESR at VHF, UHF and microwave frequenciesEnhanced RF power handling capabilityHigh stability with respect to time, temperature, frequency and voltage variation	
Oper. Temp: -55°C to +125°C Case: 0402 - 1210 Capacitance: 0.05 pF - 68 pF Tolerances: from ±0.01 pF	DLA 09034 (0402) DLA 09025 (0603) DLA 09026 (0805) DLA 09027 (1210)

RF THIN FILM INDUCTORS

DLA	
 <ul style="list-style-type: none">High QRF Power CapabilityHigh SRFLow DC ResistanceUltra-Tight Tolerance	
Oper. Temp: -55°C to +125°C Case: 0402 - 0805 Inductance: 0.56 nH - 22 nH Tolerances: from ±0.05 nH	DLA 11017 (0402) DLA 11018 (0603) DLA 11019 (0805)

ESTABLISHED RELIABILITY PRODUCTS

 <ul style="list-style-type: none">Tantalum CapacitorsTHH 230°C Hermetically SealedNickelum Oxide	 <ul style="list-style-type: none">AntennasOmni-direction Transceiver Antennas	 <ul style="list-style-type: none">Multilayer VariatorsDSCC AA555682 (Industrial Grade)	 <ul style="list-style-type: none">NTC ThermistorsSMT and Leaded	 <ul style="list-style-type: none">Film CapacitorsHigh PowerMedium PowerDC Film
 <ul style="list-style-type: none">MIL-C 55074 Harmanprocon styleMIL-C-55074 Compliant	 <ul style="list-style-type: none">M55032 DINM55302 Compliant	 <ul style="list-style-type: none">Varicon • Rack and PanelMIL-E-5400, MIL-E-8169, MIL-T-21200, MIL-C-21097, MIL-C-26731, MIL-C-55302 Compliant	 <ul style="list-style-type: none">MIL-C 55074 Harmanprocon styleMIL-C-55074 Compliant	 <ul style="list-style-type: none">MIL-C 55074 Harmanprocon styleMIL-C-55074 Compliant

Click to follow link



[High Reliability, Defense, & Space Application Guide \(kyocera-avx.com\)](https://www.kyocera-avx.com)

THANK YOU.



KYOCERA-AVX.com

smiths interconnect

SPCD
SPACE PASSIVE COMPONENT DAYS



SPCD, ESA - ESTEC Noordwijk, 15-18th October 2024

New SPL Series of fixed attenuator and Thermopad® products for New Space Applications

Dave Raymond – Product Line Manager BLC's
Julien PICARD – Sales Manager EMEA

Smiths Interconnect Proprietary Information – For Exclusive Use of the Addressed Party Only

CUTTING-EDGE
CONNECTIVITY

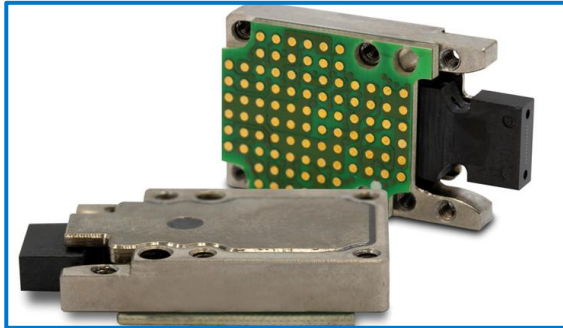
Smiths Interconnect Business Unit Structure

A Business Unit structure focused on offering cutting-edge solutions to address customers' needs across many markets



Connectors

High-reliability electrical interconnect solutions from highly integrated assemblies to microminiature connectors and spring probe contacts



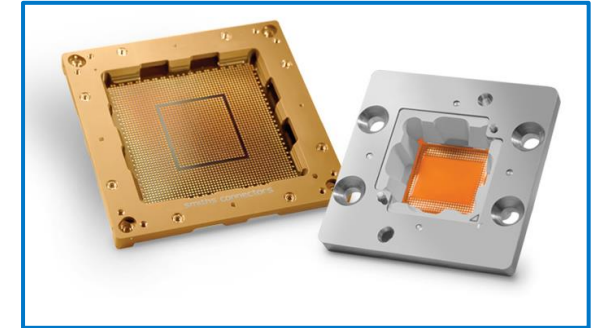
Fibre Optics and RF Components

Broad range of RF and MW devices, transceivers and transceivers modules for demanding high reliability environments



RF/MW Subsystems Smiths Interconnect Inc.

Antenna systems, multi-function RF systems, as well as SATCOM antenna solutions for Aerospace and Defence subsystem applications



Semiconductor Test

Test socket and probe card solutions with spring probe contact technology for semiconductor test applications

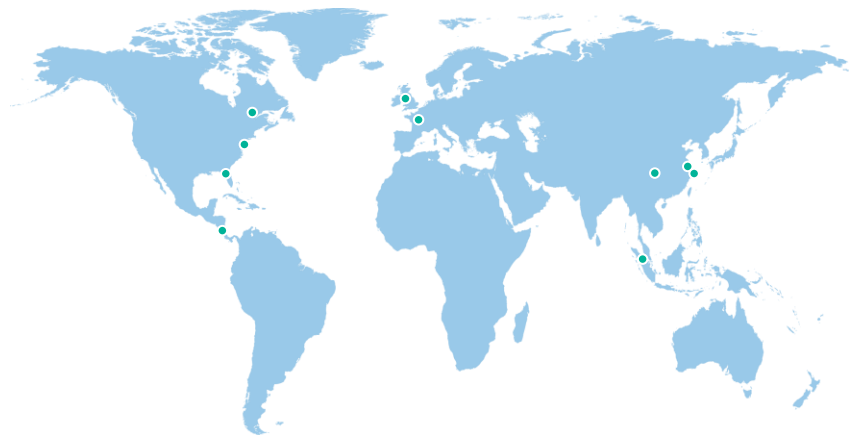
Fibre Optics and RF Components | Quick Facts and Technology Portfolio

- Broad range of RF and MW devices, transceivers and transmitter/receiver modules in a variety of packages and footprints for demanding high reliability environments
- Targeting Aerospace, Space, Defence and Communication market segments

6 Customer
Service Centres

4 Manufacturing
Sites

4 R&D
Locations



Americas

Alajuela, **Costa Rica**
Salisbury **MD, US**
Stuart **FL, US**
Kirkland **QC, Canada**

Asia

Bangalore, **India**
Shanghai, **China**

Europe

Dundee, **UK**



Board Level Components

- RF devices used to attenuate, level or terminate signals
- Extensive portfolio of commercial and application-specific components in a variety of packages and footprints



RF Cable Assemblies

- High performance microwave cable assemblies and coaxial components
- Application specific premium interconnects for durability and harsh environments



Ferrites/Waveguides

- Ferrite devices and waveguide products for space applications
- Product range includes isolators, circulators, combiners, terminations, iso-adapters, integrated assemblies



Fibre Optics

- Rugged 10G and 25G optical transceivers qualified for harsh environments
- Mount mid-board, MPO on front panel, or as a SOSA-aligned backplane connector



RF Filters

- RF/Microwave conditioning products with high selectivity using multiple topologies.
- Broad range of applications from 600 kHz to 65 GHz



Space Heritage

Smiths Interconnect has been supplying RF Passive Components, Cables and Optical Transceivers for space flight missions for over 40 years. We have participated in over 150 military, commercial and scientific satellite programs such as the Mars Exploration Rover.

40+
Years
Experience

Board level Components	RF Filters	Cable Assemblies
<ul style="list-style-type: none">High Reliability Fixed AttenuatorsThermopad® High Reliability Temperature Variable AttenuatorsHigh Power Chip AttenuatorsCoaxial TerminationsStripline Flange TerminationsStripline Pill terminationsHigh Power Flange TerminationsHigh Power Chip Resistors	<ul style="list-style-type: none">L-Band Low Pass FiltersS-Band Ceramic FiltersK-Band Waveguide FiltersKa-Band Waveguide Filters	<ul style="list-style-type: none">Semi-Rigid Cable AssembliesSpaceNXT™ Q Cable AssembliesSpaceNXT™ QT Cable Assemblies
	Ferrites & Waveguides	Optical Transceivers
	<ul style="list-style-type: none">W112 WaveguidesWaveguide Couplers and SplittersMW Isolators and CirculatorsSpaceNXT™ MWC and KU Series	<p>SpaceABLE® family includes:</p> <ul style="list-style-type: none">4+4 Transceivers12-channel Transmitters & ReceiversEngineering & Flight Model versionsLAT services

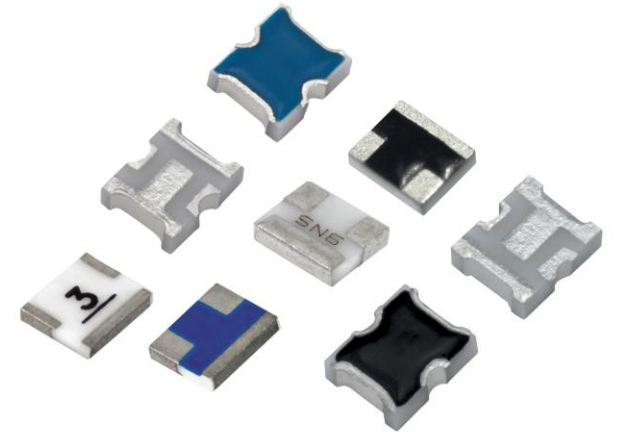
SPL Series Attenuators and Thermopads® for New Space Applications

SPL - Series of Fixed Attenuators and Thermopads® | High Volume New Space Applications

The new SPL Series of attenuator and Thermopad® products is tested to meet the space orbit environmental criteria and is offered in a high-volume solution that leverages the Smiths Interconnect's space heritage to improve reliability and performance over a QPL or COTS product. This series is supplied with all the necessary test and qualification data to ensure flight compliance at a low cost of ownership.

- Smiths Interconnect's SPL Series of attenuator and Thermopad® products use a **proven product** to provide increase reliability at a lower cost point over conventional high reliability tested product in a surface mount solutions.
- This product series are **100% electrical, mechanical and visually inspected** back up by annual lot qualification. This ensures a quality tested product that reduces both cost of ownership and lead time.
- The SPL series is back by decades of space heritage from our HR series products tested to **MIL-PRF-55342**. It offers the same base product with and alternative to longer lead time products and is ideal where reliability is needed in high volume price sensitive programs.
- This product series is offered in surface mount configurations with edge metallization for **ease of inspection** after installation. This adds to the reliability of the product in the assembly.

SPL -Series



- Surface mount edge wrap
- Thick and Thin film construction
- Multiple dB values and TCA shifts available
- Cost effective

Which are the unmet needs that our product solves?

100% testing

- This product series are 100% electrical, mechanical and visually inspected to guarantee product compliance. The data is shipped with each product order.

Annual Qualification

- Annual qualification is performed on the series to validate product reliability and performance with group A, B and C testing to MIL-PRF-55342. This test data is supplied with each product offered.

Cost Effective

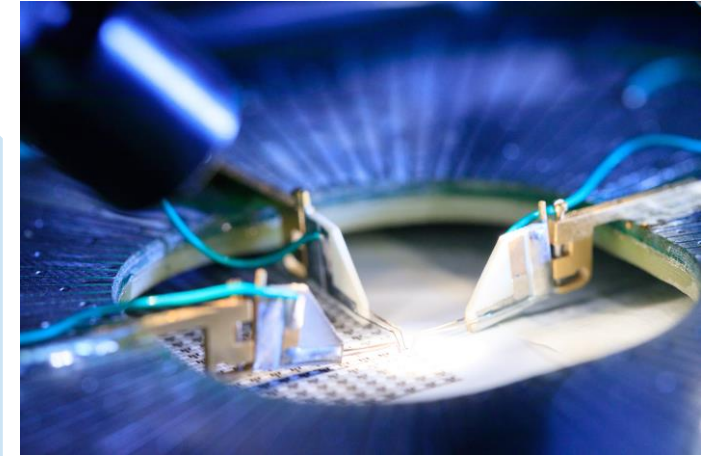
- The Series offers a single unit price with no additional associated test charges. Making this an affordable solution where reliability is necessary for cost sensitive programs.

Robust Process Technology

- Use of robust proven thick and thin film process technology provides products suitable for harsh environments such as space and defense applications.

SMT Mounting

- This product is offer in SMT mount with edge metallization to make inspection after installation possible. This is also offer in tape and reel packaging for automated pick and place.

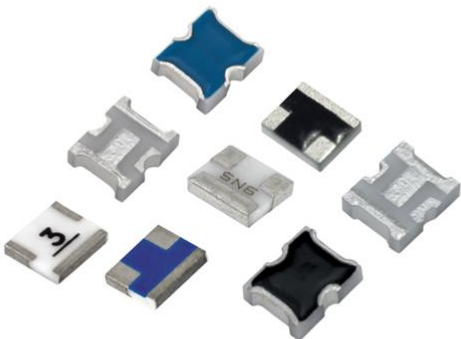


SPL Series Thermopads and Attenuators | Specifications

Fixed Attenuator Products

Standard Product Series	SPL (Smiths Product List) Series		Frequency Range (GHz)	Input Power CW (Watts)	Component Size (Inches)	Component Size (mm)
TS03	SPL-TS03		DC-12.4	2.00	0.145 X 0.122	3.68 X 3.10
TS05	SPL-TS05		DC-18	0.75 TO 5 WATTS*	0.075 X 0.060	1.90 X 1.52
TS09	SPL-TS09		DC-20	0.20	0.060 X 0.075	1.52 X 1.90

* POWER DEPENDS ON dB VALUE CHOSEN

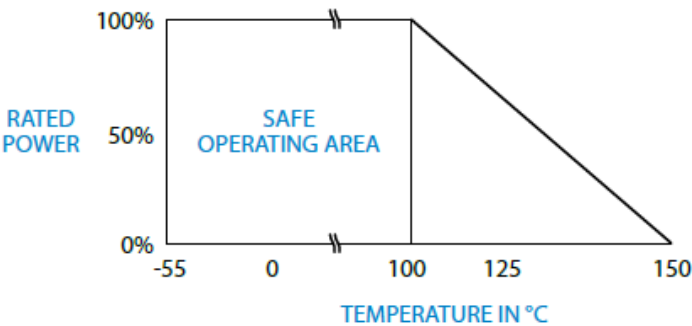


Thermopad® Products

Standard Product Series	SPL (Smiths Product List) Series		Frequency Range (GHz)	Input Power CW (Watts)	Component Size (Inches)	Component Size (mm)
TVA	SPL-TVA		DC-6	2.00	0.145 X 0.122	3.68 X 3.10
MTVA	SPL-MTVA		DC-18	0.20	0.075 X 0.060	1.90 X 1.52
WTVA	SPL-WTVA		DC-20	0.20	0.060 X 0.075	1.52 X 1.90

Environmental Specifications

Operating Temperature	-55°C to +150°C
Storage Temperature	-65°C to 150°C
Temperature Coefficient	±200 PPM/°C Max
Moisture Sensitivity Level	MSL-1 Unlimited

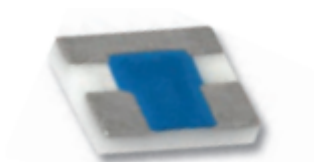


SPL Series Attenuators and Thermopads

Test Parameters per Test Plan TP-8965

Test	Sample Qty	Test Standard and Method	Test Condition
Pre-Cap Visual and Mechanical	100%	MIL-PRF-55342	30X to 60X Magnification
100% Inspection			
Visual / Mechanical	100%	MIL-PRF-55342	30X to 60X Magnification
Electrical (RF) Inspection	100%	MIL-PRF-55342	VSWR @1.0 GHz and Attenuation @ DC & 1.0 GHz - Limits per datasheet and dB Value
Subgroup 1 [TVA product only]	3		
Temperature Coefficient of Attenuation TCA (If Temp Variable Product)	3	Per Smiths Interconnect TP-8965	-55°C to +125°C - ±0.001 dB/dB/°C allowable

NOTE: Grp A, B, & C similarity test data provided with each lot / date code per Smiths work instruction 824W199.



SPL serie Testing structure can be applied to all our board level products, feel free to contact us!

Dave Raymond

Global Product Manager Board Level Devices

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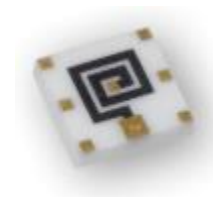
tim.meehan@smithsinterconnect.com www.smithsinterconnect.com



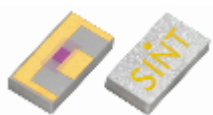
Wirebondable Terminations
(CT Series, DC-64 GHz,
0.040"x0.040")



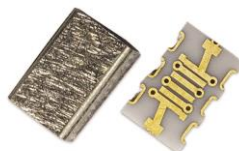
SMT Outrigger Resistors
(CHX Series, DC-27 GHz,
as small as 0402)



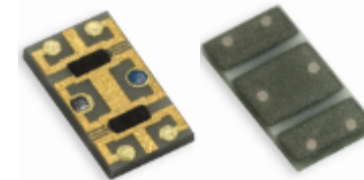
SMT Spiral Terminations
(DC-40 GHz,
0.055"x0.055")



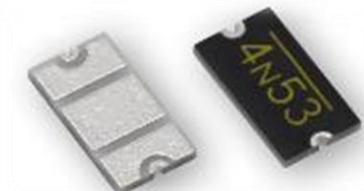
SMT RF Terminations
(CTH Series, DC-67 GHz,
0.060"x0.030")



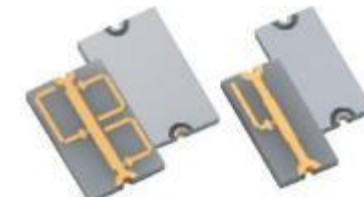
SMT Planar Filters
(DC-40 GHz,
0.200"x0.100")



Wirebondable Temperature Variable Attenuators
(K2TVA Series, DC-32 GHz,
0.120"x0.065")



SMT Temperature Variable Attenuators
(K2TVA Series, DC-32 GHz,
0.120"x0.065")



SMT Frequency Equalizers
(CEX Series, DC-40 GHz,
0.120"x0.065")



SMT Fixed Attenuators
(TSX Series, DC-40 GHz,
0.060"x0.040")



SMT Resistive and Wilkinson Dividers
(DC-40 GHz, as small as
0.060"x0.050")



Pioneers of Progress

Advancing the world through
cutting-edge connectivity

smithsinterconnect.com



smiths interconnect

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CONNECTIVITY**